

SM2016-6

## Features:

- Ultra Miniature SMD Package
- Good Frequency Stability
- Good Phase Noise Response
- Moisture Sensitivity Level (MSL) : Level-1
- AEC-Q200 compliance

## Description and Applications:

Surface mount 2.0mmx1.6mm TCXO for use in wireless communications devices

## Electrical Specifications:

XTC4010-1	Specifications
Nominal Frequency, Fo	48.0 MHz
Storage Temperature Range	-40°C to +105°C
Operating Temperature Range	-40°C to +105°C
Power Supply Voltage, Vcc	1.68~3.63 V (Nominal to 3.0V)
Output Waveform	Clipped Sinewave
Output Voltage with Load 10pF//10KΩ, Vout	0.8 Vp-p min
Power Supply Current, Icc	2.0 mA max
Frequency Tolerance as received	+/- 1.5 ppm max @ 25°C +/- 3°C
Frequency Tolerance after reflow	+/- 2.5 ppm max @ 25°C +/- 3°C
Frequency Stability a. Vs. Temperature (-40~105°C) b. Vs. Load varied 10pF//10KΩ+/-10% c. Vs. Supply Voltage varied Vcc+/-5%	+/- 5.0 ppm ( reference to 25°C ) +/- 0.3 ppm +/- 0.2 ppm
Start Up Time (90% of final RF level in Vp-p)	2.0 msec max.
Aging	+/-1.0 ppm/ first year @25°C
Harmonics	-8.0 dBc max

SSB Phase Noise (@1KHz Carrier Offset) (@10KHz Carrier Offset) (@100KHz Carrier Offset)	-135 dBc/Hz max -148 dBc/Hz max -150 dBc/Hz max
Enable/Disable Function (OE function)	Pin 1: 0.8 Vcc min, Pin 3:Enable Pin 1: 0~0.2 Vcc, Pin 3 :Disable Pin 1: Do not use in open condition
Marking	Laser marking

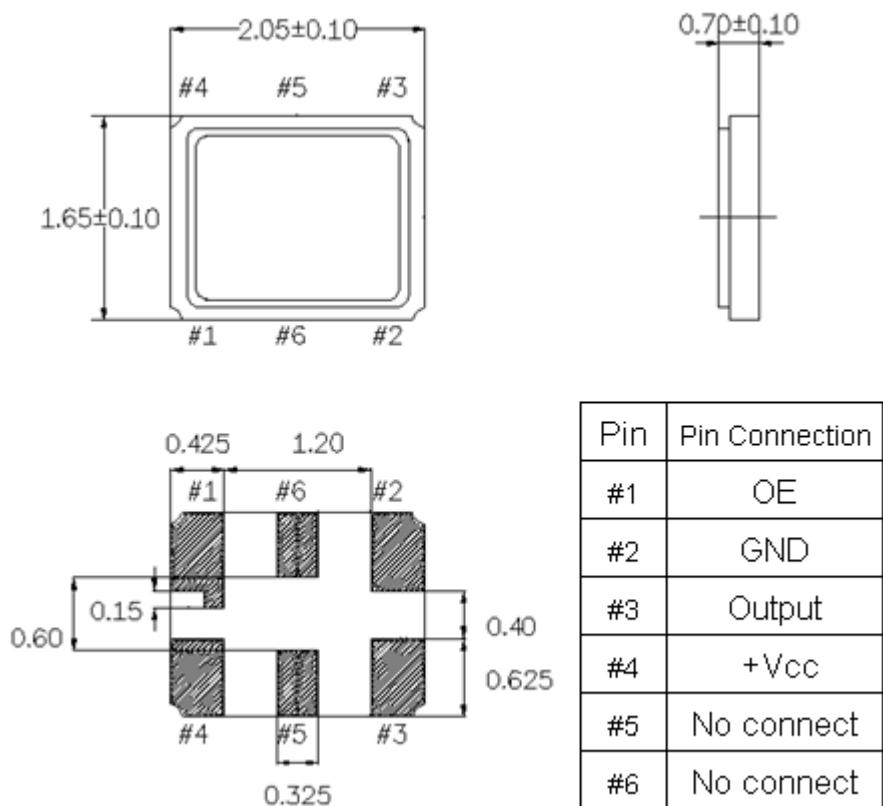


**CAUTION: Electrostatic Sensitive Device. Observe precautions for handling.**

**NOTES:**

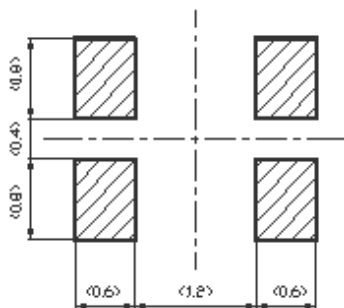
1. The design, manufacturing process, and specifications of this device are subject to change.
2. US or International patents may apply.
3. RoHS compliant from the first date of manufacture.

## Mechanical Dimensions (mm):



**Note:** This package has two extra pads in the middle (pin #5 and #6) that are used to test the internal Xtal by the factory, but are not intended for customer use. Do not place ground (GND) patterns (including ground pads, via holes, etc.) under the crystal unit, especially under pin #5 and #6. Also, do not run RF signal power or digital line under the package in the multi-layered PCB.

## Recommended Land Pattern: (unit: mm)



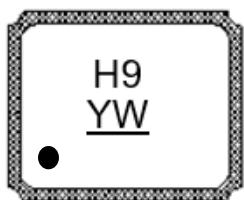
## Marking:

Line 1: H9

Line 2: Y = Year, W = Week

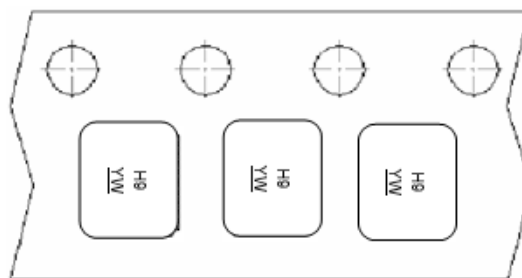
Pin#4

Pin#1

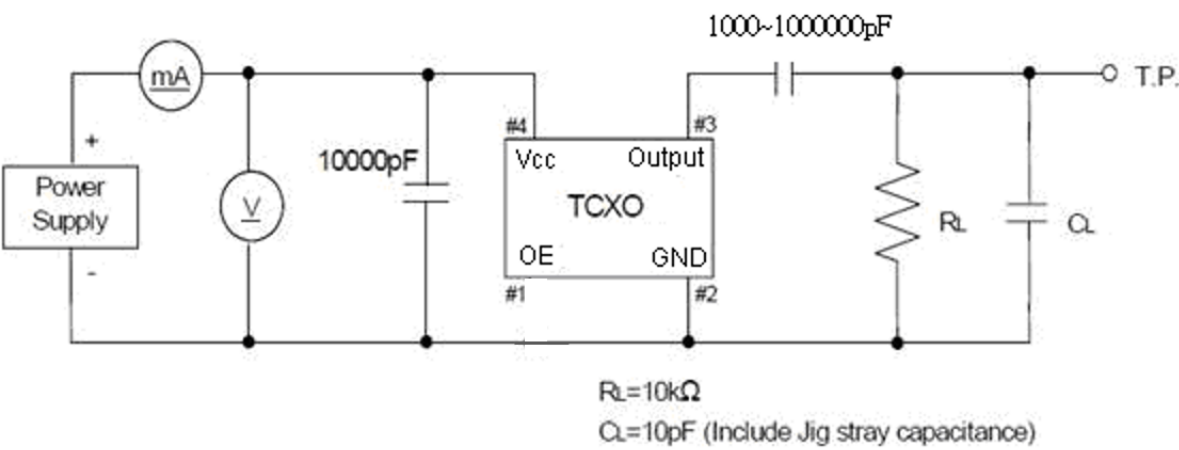


Pin#3

Pin#2



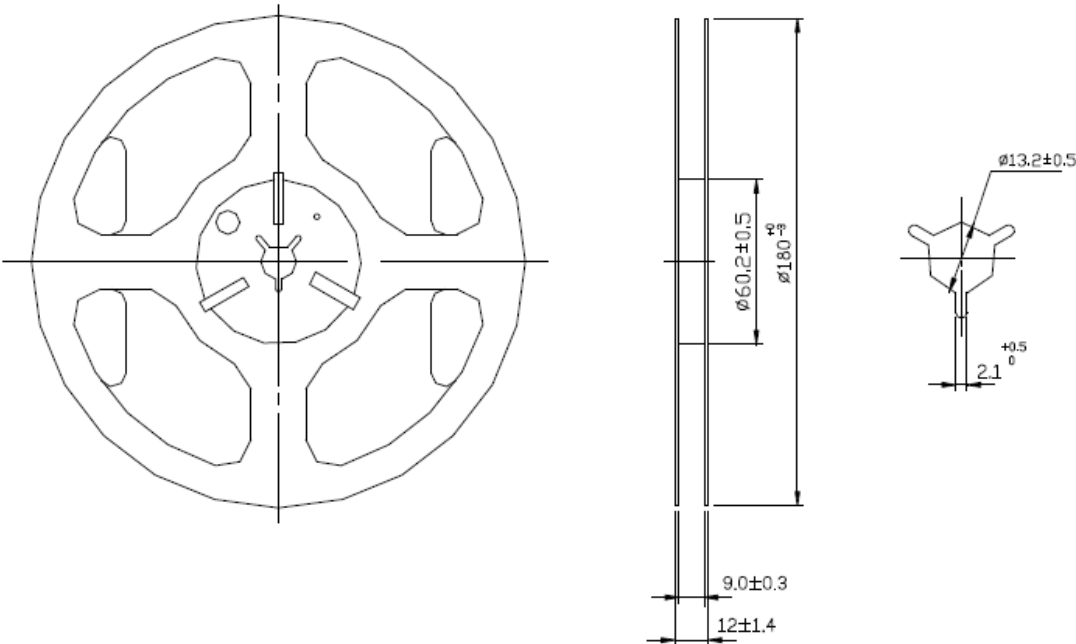
# Recommended Circuit



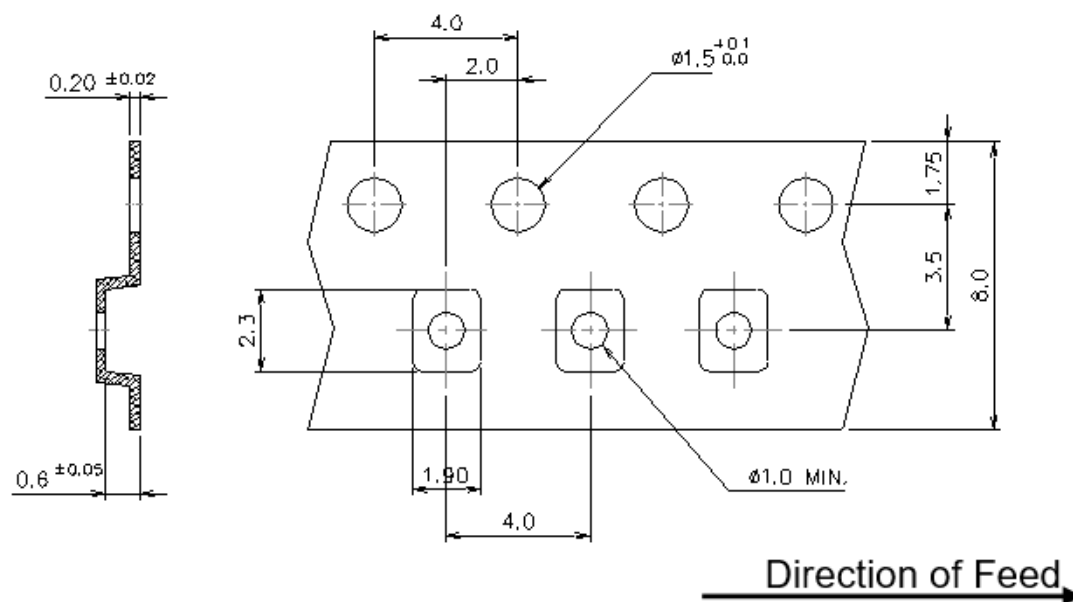
## Reel Dimension

Reel Count:  
7" = 3000

Tape and Reel Standard per ANSI/EIA-481



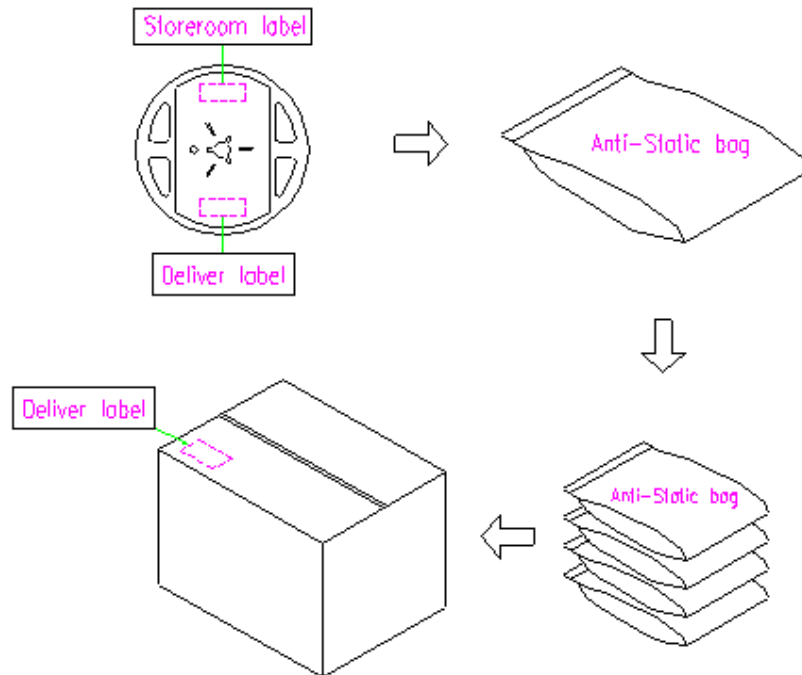
## Tape Dimensions (mm):



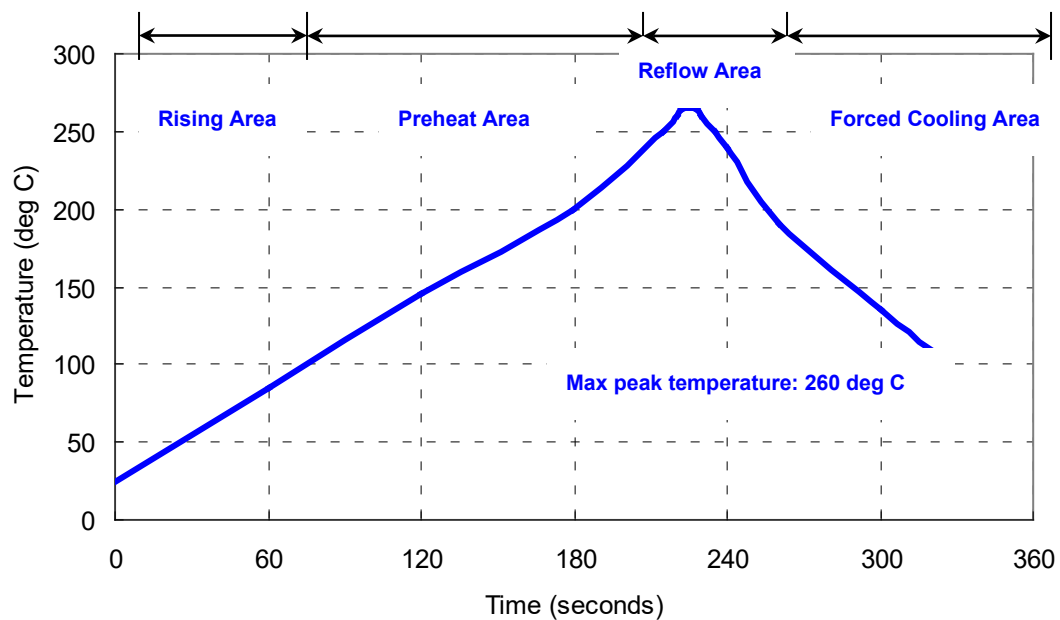
### [NOTE]:

1. Unless otherwise specified tolerance on dimension  $\pm 0.1$  mm.
2. Material: conductive polystyrene with color black.
3. 10 pitch cumulative tolerance  $\pm 0.2$  mm.

## Packing Quantity/Packing: 3K pcs maximum per reel



## Reflow Profile:



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## Notes of the Usage:

1. Touch the solder iron at  $260 \pm 5$  deg C onto the leads for  $10 \pm 2$  sec max or touch the solder at  $350 \pm 5$  deg C onto the leads for  $3 \pm 0.5$  sec.
2. In the customer's reflow process, if it will remain some mechanical stress at the soldering terminals, also make some cracks on the soldering termination. Some cracks will cause open or short circuit and cause of thermal increasing or smoking. Don't make any excess mechanical stress to soldering points.
3. In case of giving a heavy shock to the products, it may make an open or short circuit and cause of thermal increasing and smoking. To avoid heavy shock impact applying to products is strictly required.
4. Ultrasonic cleaning should be avoided to prevent damage to the TCXO.
5. Do Not Use Ultrasonic-Wave Soldering or Wave Solder with Package Immersed in Solder.

## Notes of the Storage:

1. To keep products under the condition at the room temperature ( $-5 \sim 35$  deg C) with normal humidity ( $45 \sim 75\%$ ). Absorption of moisture and dewdrop may make inferiority of characteristics and a short circuit.
2. Oxidization of terminals shall make the solderability more inferior. Dusts and corrosive gas will make a cause of the open or short circuit. Keep it in the clean place where is not in dusty and no corrosive gas.
3. Use the anti-static material to the storage package.
4. Don't put any excess weight to the TCXO in the storage process.
5. Don't move the product from the cold place to the hot place in the short time, otherwise it may make some dew-drop, then a short circuit may happen in case.
6. Storage periods should be maximum 6 months under condition of above item 1 after delivery from the factory.
7. Once open the bag, there is possibility of electrical characteristics deterioration due to absorption of moisture. So, please use parts within 7 days after opening the bag.
8. If you have to keep parts without using after opening the bag, please put the drying agent in the bag, fold the bag and keep it in the place where temperature and humidity are controlled (nitrogen atmosphere box etc.)

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